





100V INPUT, 8.2V 40mA REGULATOR TRANSISTOR POWERDI®5

Description

The ZXTR2008P5 monolithically integrates a transistor, Zener diode and resistor to function as a high voltage linear regulator. The device regulates with an 8.2V nominal output at 15mA. It is designed for use in high voltage applications where standard linear regulators cannot be used. This function is fully integrated into a PowerDI-5 package, minimizing PCB area and reducing number of components when compared with a multi-chip discrete solution.

Features

- Series Linear Regulator Using Emitter-Follower Stage
- Input Voltage = 12V to 100V
- Output Voltage = 8.2V ± 10%
- Fully integrated into a PowerDI-5 package
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Applications

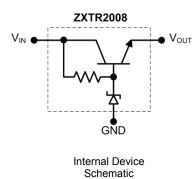
Supply voltage regulation in:

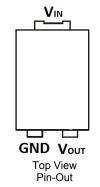
- Networking
- Telecom
- Power Over Ethernet (PoE)

Mechanical Data

- Case: PowerDI-5
- Case Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.100 grams (approximate)







Pin Name	Pin Function
Vin	Input Supply
GND	Power Ground
Vout	Voltage Output

Ordering Information (Note 4)

Product	Package	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTR2008P5-13	PowerDI-5	ZXTR2008	13	16	5,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
- 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



ZXTR2008 = Product Type Marking Code

Older Marking

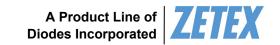
K = Factory Designator

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 14 for 2014)

WW = Week code (01 to 53)





Absolute Maximum Ratings (Voltage relative to GND, @TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Supply Voltage	V _{IN}	-0.3 to 100	V
Continuous Input & Output Current	I _{IN,} I _{OUT}	450	mA
Peak Pulsed Input & Output Current	I _{IM} , I _{OM}	2	Α
Maximum Voltage applied to V _{OUT}	V _{OUT(max)}	14.5	V

Maximum Current at V_{IN} = 48V (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Continuous Output Current	(Note 7)	I _{OUT}	45	mA	
Pulsed Output Current	(Note 8)		800	mΛ	
Pulsed Output Current	(Note 9)	Іом	160	mA mA	

Thermal Characteristics

Characteristic	Symbol	Value	Unit		
Power Dissipation	(Note 5)	В	1.82	\\\	
Power Dissipation	(Note 6)	P _D	0.94	W	
Thermal Desistance Junation to Ambient	(Note 5)	Б	55		
Thermal Resistance, Junction to Ambient	(Note 6)	R _{θJA}	107	°C/W	
Thermal Resistance, Junction to Lead	(Note 10)	$R_{\theta JL}$	20	C/VV	
Thermal Resistance, Junction to Case (Note 10)		R _{0JC}	17.8		
Recommended Operating Junction Temperature	T_J	-40 to +125	°C		
Maximum Operating Junction and Storage Temperature Range		T _J , T _{STG}	-65 to +150	C	

ESD Ratings (Note 11)

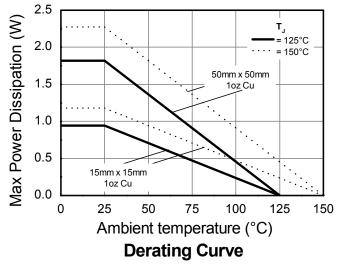
Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	С

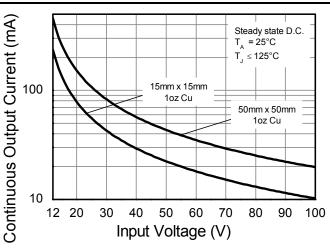
Notes:

- 5. For a device mounted with the exposed V_{IN} pad on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
- 6. Same as Note 5, except mounted on 15mm x 15mm 1oz copper.
- 7. Same as Note 5, while operating at V_{IN} = 48V. Refer to Safe Operating Area for other Input Voltages.
- 8. Same as Note 5, except measured with a single pulse width = 100μ s and V_{IN} = 48V.
- 9. Same as Note 5, except measured with a single pulse width = 10ms and V_{IN} = 48V.
- 10. $R_{\theta JL}$ = Thermal resistance from junction to solder-point (on the exposed V_{IN} pad).
 - $R_{ heta JC}$ = Thermal resistance from junction to the top of case.
- 11. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

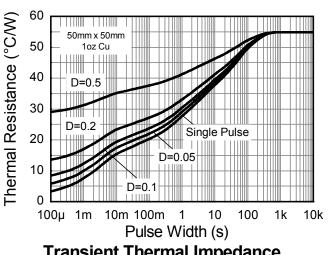


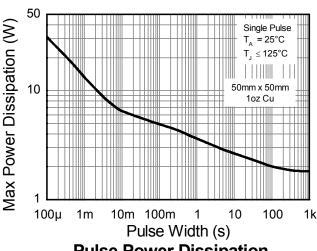
Thermal Characteristics and Derating Information





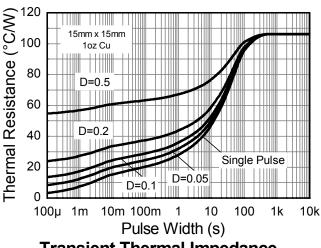
Safe Operating Area

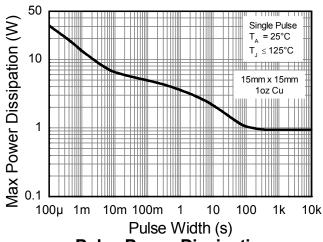




Transient Thermal Impedance

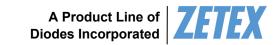
Pulse Power Dissipation





Transient Thermal Impedance





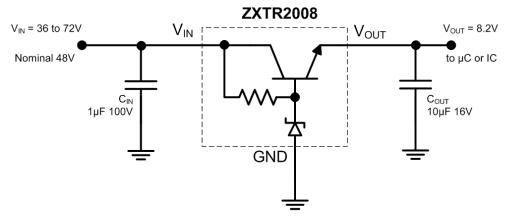
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Output Voltage (Note 12)	V _{OUT}	7.38	8.2	9.02	V	V _{IN} = 48V, I _{OUT} = 15mA
Line Regulation (Notes 12 & 13)	ΔV_{OUT}	_	10	300	mV	V _{IN} = 12 to 100V, I _{OUT} = 15mA
Temperature Coefficient	ΔV _{OUT} /ΔΤ	l	10		mV/°C	$T_J = -40$ °C to +125°C $V_{IN} = 48V$, $I_{OUT} = 15$ mA
Load Regulation (Notes 12 & 14)	ΔV _{OUT}	_	-180 -250	-400 -500	mV	I _{OUT} = 0.1 to 30mA, V _{IN} = 48V I _{OUT} = 0.1 to 100mA, V _{IN} = 48V
Minimum Value of Input Voltage Required to Maintain Line Regulation	V _{IN(MIN)}	12	_	_	V	_
Quiescent Current	ΙQ		275 650	500 900	μA	V _{IN} = 48V, I _{OUT} = 10μA V _{IN} = 100V, I _{OUT} = 10μA
Power Supply Rejection Ratio	$\Delta V_{IN} / \Delta V_{OUT}$	_	38	_	dB	C _{OUT} = 100nF, I _{OUT} = 15mA, V _{OUT} = 8.2V, V _{IN} =12 to 100V, f=100Hz

Notes:

- 12. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.
- 13. Line regulation $\Delta V_{OUT} = V_{OUT}(@V_{IN} = 72V) V_{OUT}(@V_{IN} = 15V)$
- 14. Load regulation $\Delta V_{OUT} = V_{OUT}(@ I_{OUT} = 30 \text{mA}) V_{OUT}(@ I_{OUT} = 0.1 \text{mA})$
 - $\Delta V_{OUT} = V_{OUT}(@ I_{OUT} = 100 \text{mA}) V_{OUT}(@ I_{OUT} = 0.1 \text{mA})$

Typical Application Circuit



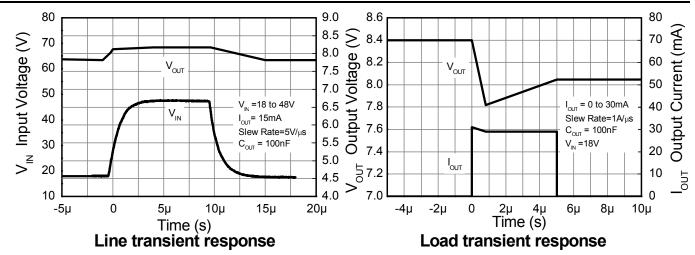
Example of an 8.2V regulated supply from a nominal 48V for powering a Controller IC.

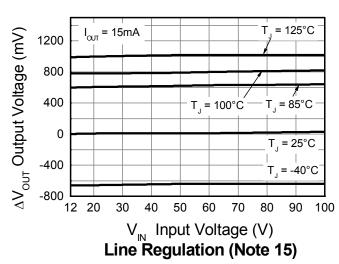
Pin Functions

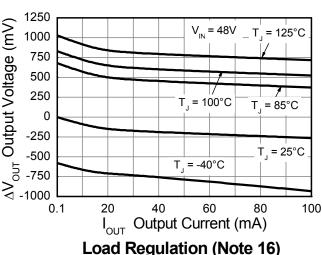
Pin Name Pin Function		Notes
V _{IN} Input Supply To maintain output regulation the input voltage can vary from 12V to 100V with respect to the GND p recommended to connect a 1μF capacitor to GND.		
GND Power Ground This pin should be tied to the system ground.		This pin should be tied to the system ground.
V _{OUT}	Voltage Output	Outputs a regulated 8.2V. It is recommended to connect a $10\mu F$ capacitor to GND. Minimum of $10\mu A$ must be drawn from V_{OUT} to maintain regulation. The pin can be pulled high to a maximum of 14.5V with respect to ground.

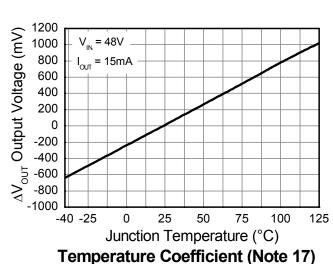


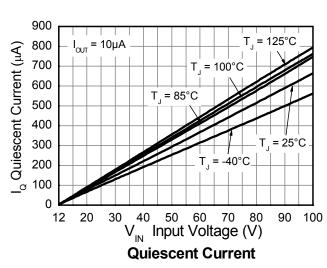












Notes: 15. Line regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@ V_{IN} = 15V, I_{OUT} = 15mA, T_J = +25^{\circ}C)$

16. Load regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@V_{IN} = 48V, I_{OUT} = 0.1 mA, T_J = +25 °C)$

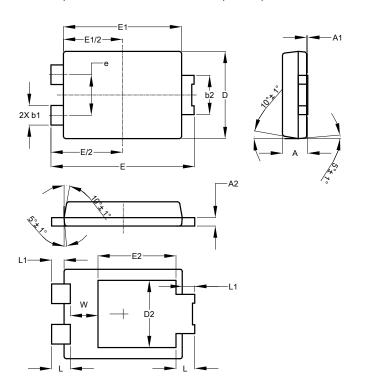
17. Temperature Coefficient $\Delta V_{OUT} = V_{OUT} - V_{OUT} (@V_{IN} = 48V, I_{OUT} = 15mA, T_J = +25^{\circ}C)$





Package Outline Dimensions

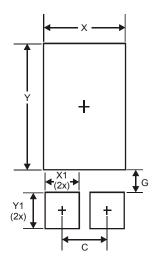
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



POWERDI [®] 5					
Dim	Min	Max	Тур		
Α	1.05	1.15	1.10		
A2	0.33	0.43	0.381		
b1	0.80	0.99	0.89		
b2	1.70	1.88	1.78		
D	3.90	4.05	3.966		
D2	-	-	3.054		
Е	6.40	6.60	6.504		
е	-	-	1.84		
E1	5.30	5.45	5.37		
E2	-	ı	3.549		
L	0.75	0.95	0.85		
L1	0.50	0.65	0.57		
W	1.10	1.41	1.255		
All Dimensions in mm					

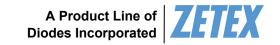
Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
C	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400





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